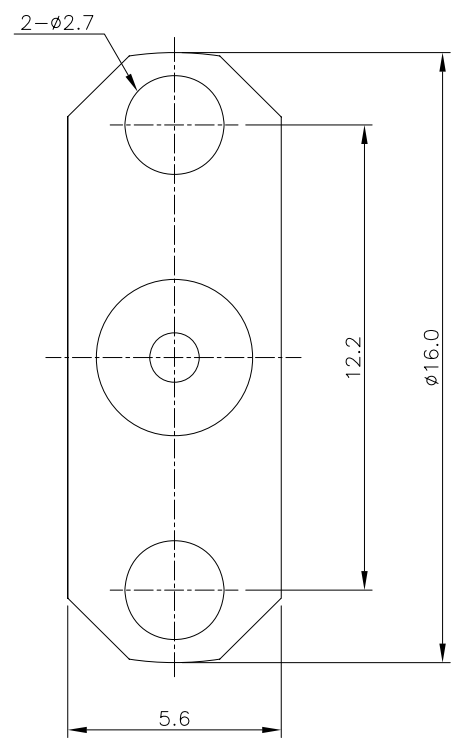
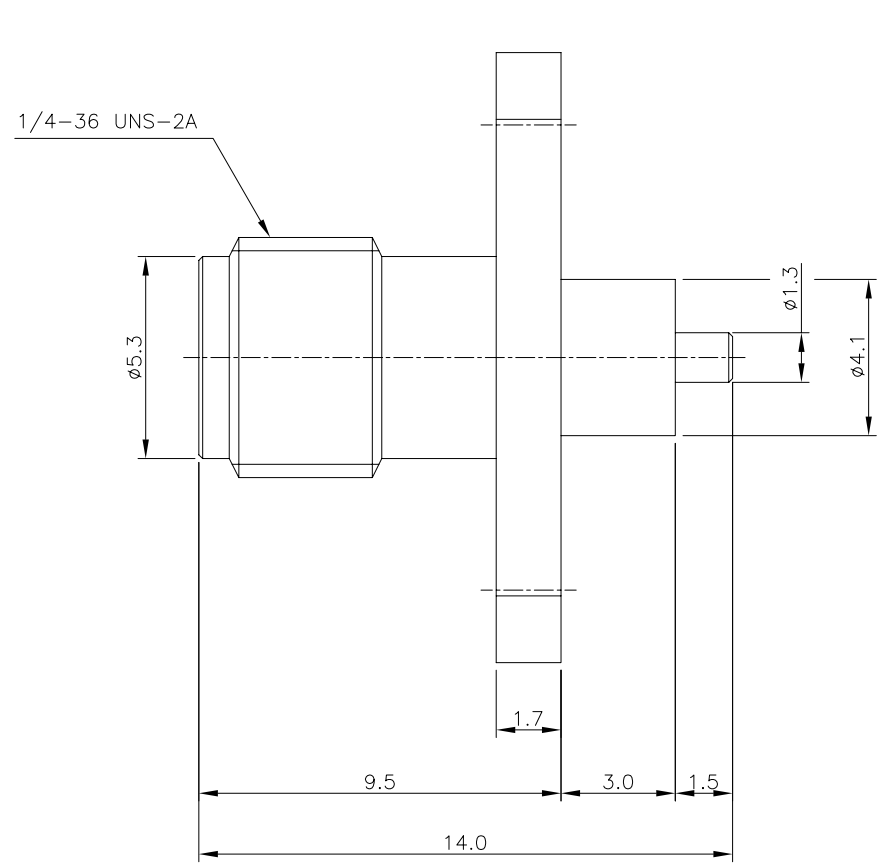


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1	Initial Registration	E.H.KIM	I.C.KIM	2014. 08. 27.



3	INSULATOR	1	TEFLON		DIN00190-N/1 (HA181B)
2	CONTACT	1	BeCu	Gold Plate	DCT00225-5/1 (E2360)
1	BODY	1	MBsBD	Gold Plate	DBD00347-5/1 (D2036)
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2014. 08. 27.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL	-	CHECKED BY	-	TITLE SMA50 SOLDER END J-2H
		DRAWN BY	E.H.KIM	
FINISH	-	SCALE	5/1	DWG NO. CN03273-7/1 REVISION I R SHEET 1 of 1
		UNIT	mm	

REVISION

REV	DESCRIPTION	DRAWN	APPR	DATE
1	Initial Registration	E.H.KIM	I.C.KIM	2014. 08. 27.

1/4-36 UNS-2A

2-ø2.7

12.2

ø16.0

5.6

9.5

3.0

1.5

14.0

ø4.1

ø1.3

1.7



RF & MICROWAVE
TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE
SMA50 SOLDER END J-2H

DWG NO. CN03273-7/1
REVISION I R SHEET 1 of 1

A4

